

“Electrify Our World™”



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Navitas

Energy • Efficiency • Sustainability



GaN Video



Navitas

▶ 🔊 Gallium Nitride: Electrify Our World™ ⚙️ 📺

0:01 / 1:40





- 🌀 **Energy** to revolutionize power electronics
- 🌀 **Energy** to accelerate change
- 🌀 **Energy** to make a sustainable difference for our world





Efficiency

The Future is GaNFast

GaN is a high-speed semiconductor that switches up to 100x faster than Si and enables more efficient, smaller, lighter, cooler and lower cost systems; delivering 30-40% in energy savings.





Sustainability

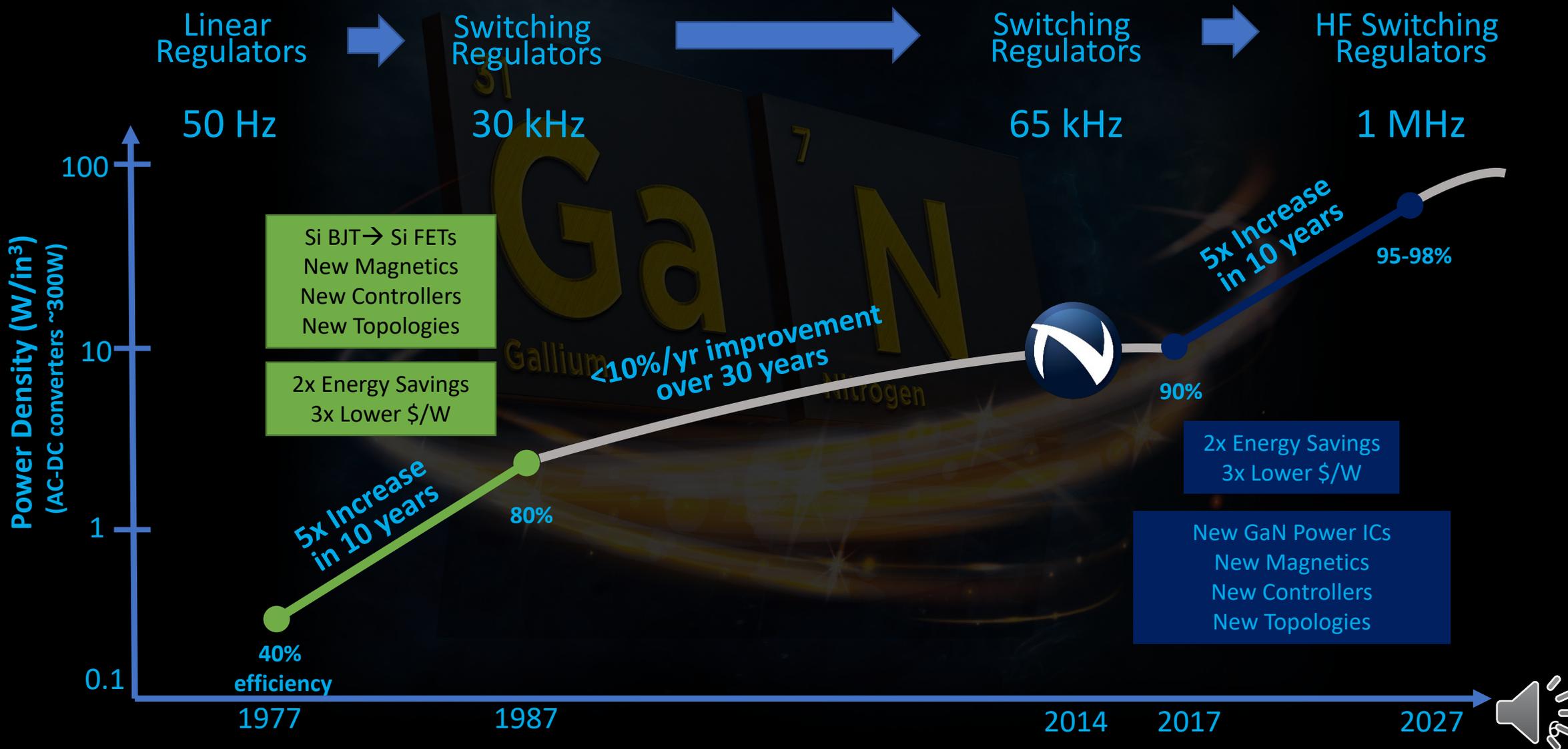
By the 2050 timeline of the Paris Accord, GaN will address a 2.6 Gtons/year reduction in CO₂

- **Over 6.5 trillion** miles driven by an average car,
- **Over 6 billion** barrels of oil, or
- **650** fewer coal power plants



Once every 40 years...

Second Revolution in Power



The Enabling Force



20x

Faster
Switching

3x

Smaller &
Lighter

Up To
40%

Energy
Savings

Up To
3x

Higher
Power Density

3x

Faster
Charging

20%

Lower
System Cost

Note: Statistical data is based on Navitas estimate of GaN-based power systems compared to Si-based systems in the 2024-2025 timeframe. Based on Navitas measurements of select GaN-based mobile wall chargers compared to Si-based chargers with similar output power. Relative to silicon, GaN has 10x stronger electrical fields and 2x greater electron mobility, enabling high voltages in fast chips and fast switching with high energy savings.



GaN Integration Is Key To Speed, Efficiency And Size



Navitas' proprietary integration unlocks GaN's potential

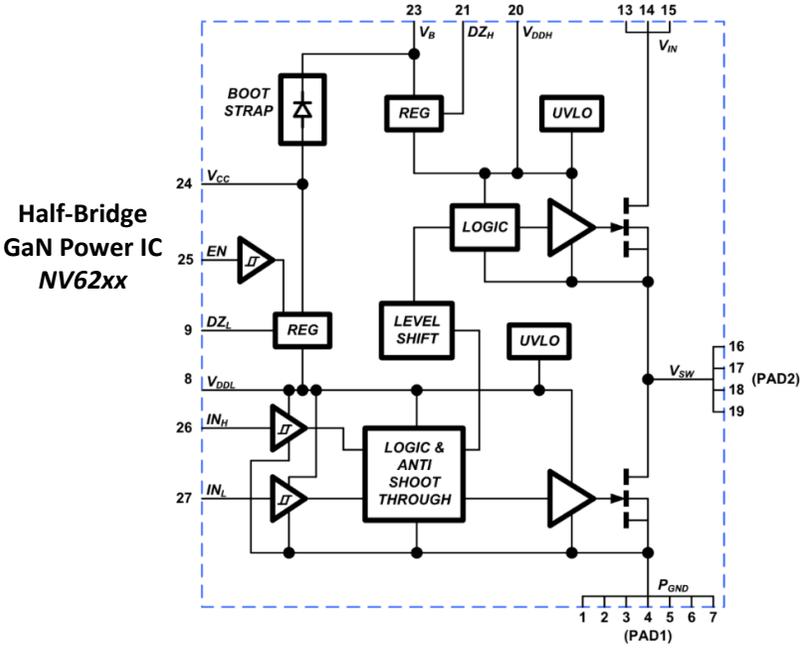
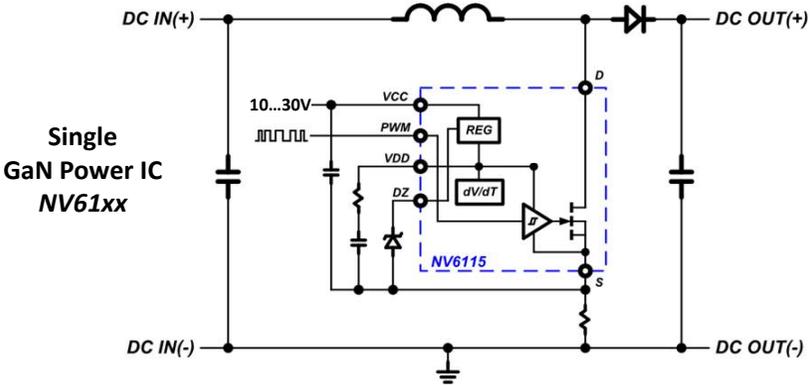
Solution	Drive, Control & Protection	Power	Speed (Switching Frequency)	Passive & Mechanical Components	Energy Efficiency	Size & Weight Density
Navitas GaN Power ICs	<p>Compact, integrated solution Combines drive, control, protection and power</p>		<p>2MHz</p>	<p>Small / Light</p>	<p>92-95% (40% energy savings)</p>	<p>3x</p>
Discrete GaN			<p>500kHz</p>	<p>Medium Size / Weight</p>	<p>88-92% (20% energy savings)</p>	<p>2x</p>
Silicon			<p>100kHz</p>	<p>Large / Heavy</p>	<p>85-90%</p>	<p>1x</p>

Note: Based on Navitas estimate for typical 65W mobile wall charger.

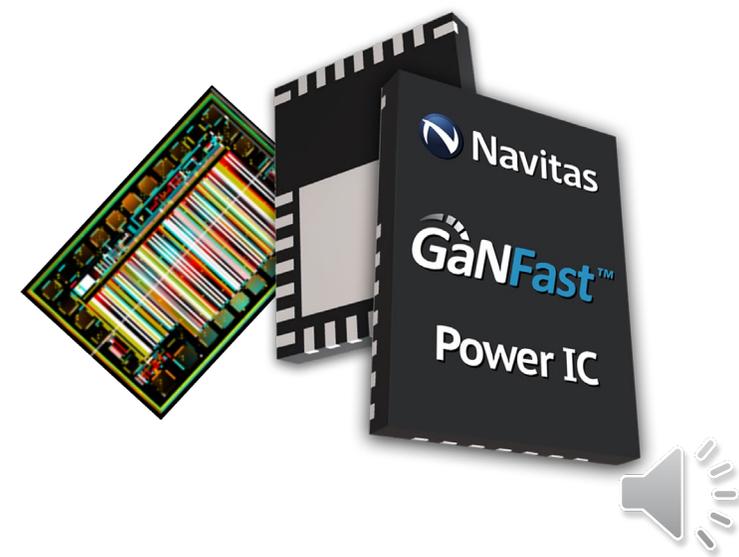
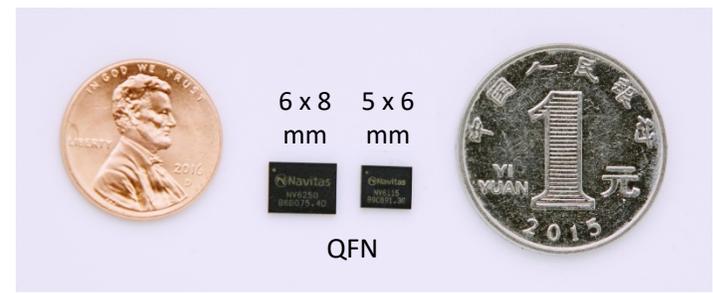
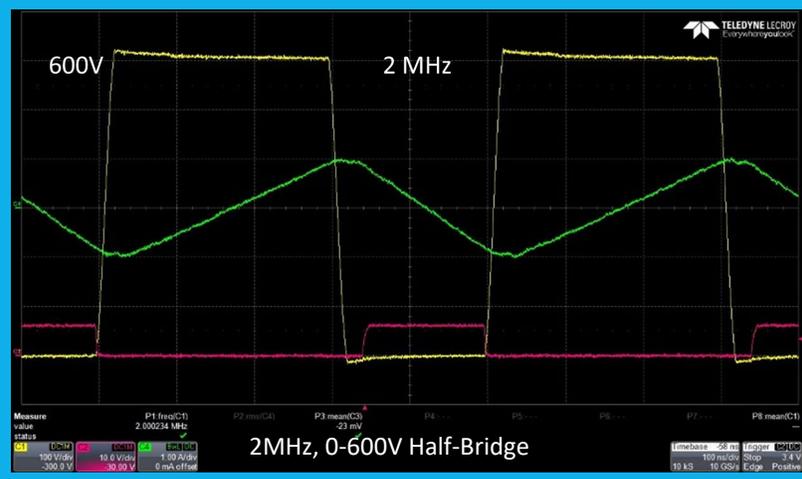




GaNFast™ Power ICs: Single, Half-Bridge



- “Digital In, Power Out”
- 650V/800V, 2MHz
- Monolithic integration
- GaN Power FET(s), GaN Driver, Control and Protection
- On-board regulators, hysteretic input, level-shift, bootstrap
- dV/dt control, UVLO, shoot-through & ESD protection



Leadership in: *Industry Experience & Impact*



Gene Sheridan
Co-Founder
& CEO



Dan Kinzer
Co-Founder
& CTO/COO



Nick Fichtenbaum
Co-Founder
& VP Engineering



Jason Zhang
Co-Founder
& VP Applications,
Technical Marketing



David Carrol
Sr VP Worldwide
Sales



Stephen Oliver
VP Corporate Marketing
& Investor Relations



Marco Giandalia
VP IC Design
Engineering



Anthony Schiro
VP Quality
& Sustainability



Todd Glickman
VP Finance



Charles Zha
VP & GM
Navitas China



Lip-Bu Tan
Advisor

1st GaN power IC 2014

1st commercial planar
MOSFETs (co-inventor)

1st integrated driver + FET

1st High-Voltage Power ICs

1st p-ch power MOSFET

300+ years of power semiconductor experience¹

>\$4B/yr revenue created²

320+ patents

20+ generations of
power semiconductors

>5,000 power products

200+ technical papers



120+ employees, 70% of management with PhD, MSEE, MBA

News, May 7th 2021: “Navitas Semiconductor, the Industry Leader in Gallium Nitride (GaN) Power ICs, to Go Public at an Enterprise Value of \$1.04 Billion via Live Oak II SPAC Business Combination”



(1) Based on cumulative professional experience of the Navitas senior management team. Navitas estimate based on co-founder accomplishments spanning their professional careers.

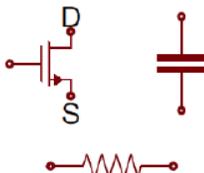
Leadership in: *Innovation*

- Industry inventor and pioneer for GaN power IC
- Multi-year lead over all other GaN suppliers
- 120+ patents
 - Proprietary AllGaN™ PDK
 - Integrated drive, control and protection with proprietary GaN power FET
 - High-frequency packaging
 - High-frequency systems



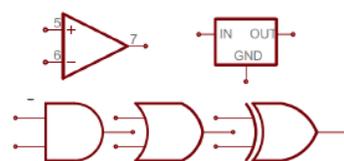
Device Development / Library

- 650V eMode power FET
- 12-40V eMode power FET
- 650V dMode power FET
- 12-40V dMode power FET
- 2-DEG & SiCr resistors
- Gate capacitors
- MIM / hybrid capacitors
- Over 20 devices developed



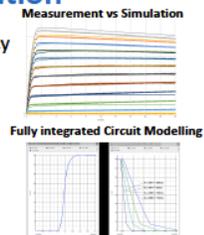
Circuit Development / Library

- Logic gates & latch
- Linear regulators
- Comparators
- Voltage sensors
- Charge pump
- Bootstrap circuits
- Level-shifters
- Protection circuits
- Over 20 circuits developed



Models & Simulation

- Device & circuit models w/ <5% accuracy
- Ultra-fast system simulations (Simplis)
- Accurate and fast device, circuit and system models cut design time from weeks to days and reduce design cycles by 50-75%



Characterization & Verification

- Dedicated & automated characterization stations (wafer level, package)
- Safe Operating Area (SOA)
- Layout Design Rule Checker (DRC)
- Layout Versus Schematic (LVS)
- Layout Parasitic Extraction and simulation tool (LPE)
- Over 1Mμ characterized



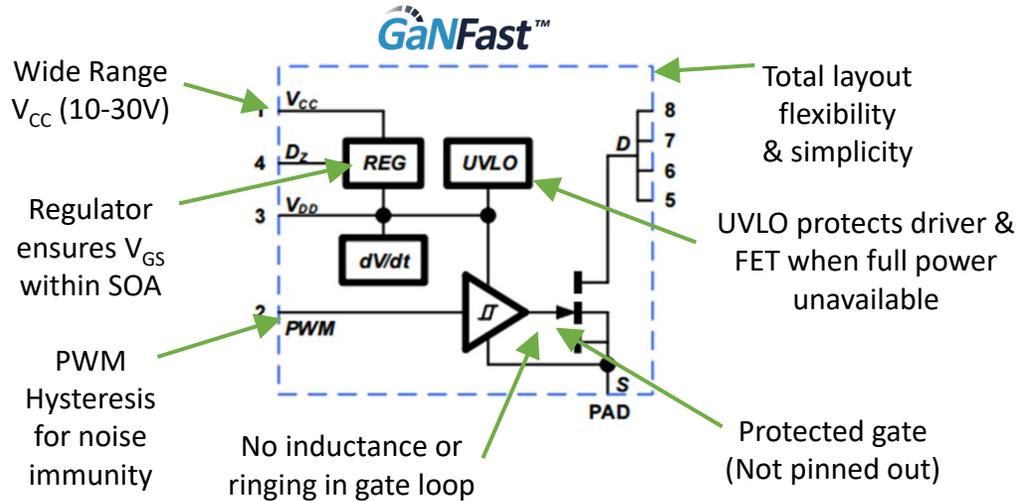
Overcoming Key Barriers To Entry

	Significant Barriers to Entry		Proprietary GaN IC
 Manufacturability	Poor Manufacturing / Yields Material mismatch (GaN / Silicon)	 Founding Team with 30+ Years of GaN Experience	Stable >90% Yields ⁽¹⁾
 Reliability	Poor Reliability Defect densities		Fully-Qualified, >1B Device Hours Tested, >20Mu Shipped ⁽²⁾ , Zero Failures ⁽³⁾
 Complexity	Extra System Components Difficult to drive, control and protect GaN FET		Single Integrated IC Solution
 Cost	High Manufacturing Costs 2x-3x Si Limited GaN production capacity		Low GaN Manufacturing Costs Volume, Integration & Manufacturing Leadership

(1) Based on Navitas production data over prior 6 months for highest volume products based on wafer-level and final test yield results.
 (2) Based on cumulative production shipments through Q1 2021.
 (3) Based on no customer-reported consumer failures for production shipments through March 2021.

Leadership in: Reliability

Reliability by Design



Field-Proven Reliability

As of May 3rd, 2021

20,000,000 GaNFast power ICs shipped	46.4B Device Hours In the Field
0 Field Failures	0 Field PPM
0.16 FIT Rate	5.8B Equivalent Device Hours Tested

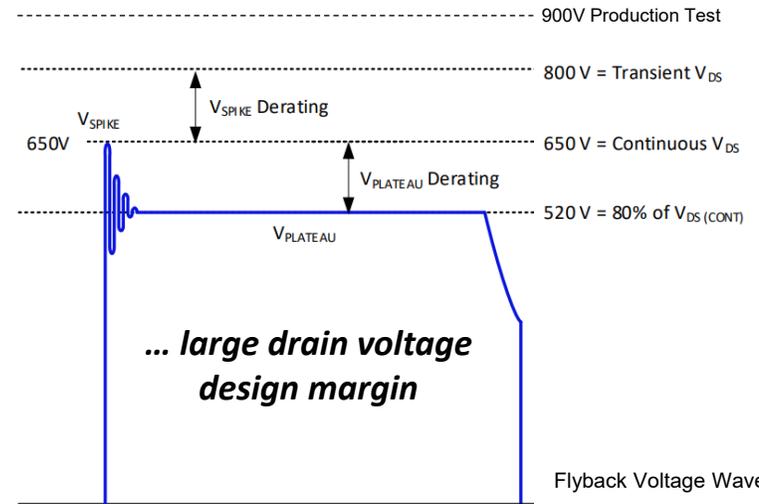
GaNFast power ICs shipped: Production material only.
 Device Hours in the Field: assumes 3-month allocation for transits, distribution and customer assembly times.
 Field Failures: confirmed GaN-related field-use failures.
 Field ppm: Parts per million defect ratio (# field failures / # Million units shipped)
 FIT Rate: 'Failures In Time' (# Reliability Test Failures / Billion Equivalent Device Hours)
 Equivalent Device Hours Tested: Total device hours tested x reliability acceleration factors.

Integrated Gate Reliability



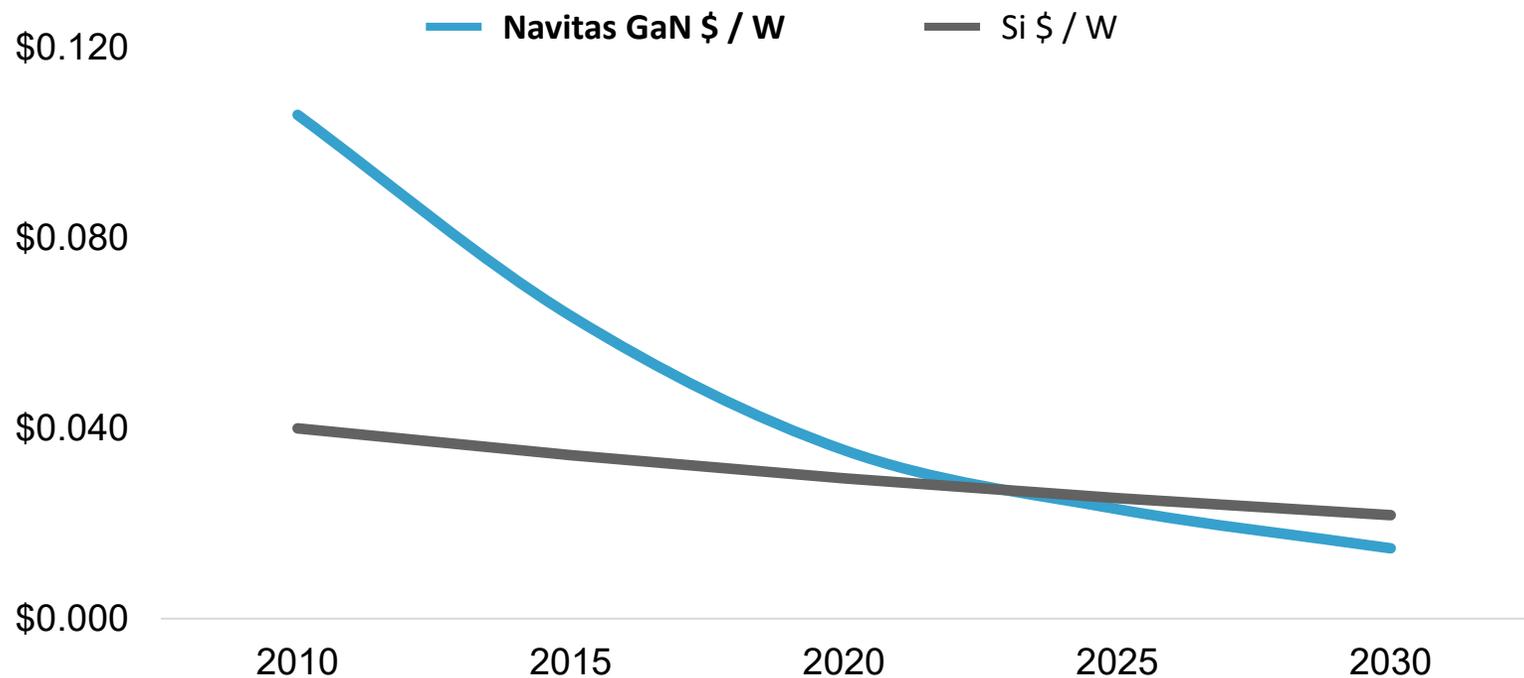
- Exposed gate
- Faulty switching
- Dangerous ringing & glitching!
- Significant reliability risks
- Integrated gate drive
- Clean switching
- Safe, robust and reliable performance

Integrated Drain Reliability



Leadership in: System Cost

Navitas GaN vs Silicon – \$/W ⁽¹⁾



Navitas Advantage

Early Mover Advantage

High yields and
low manufacturing cost⁽²⁾

New GaN Generations Every Year

Cost and performance improvements
each generation

Increasing Levels of GaN Integration Every Year

Lower customer implementation costs

Faster GaN Performance Every Year

Smaller and lower cost external
components every year

(1) Navitas estimate comparing cost of GaN-based vs Si-based wall charger bill-of-materials cost (high-voltage power device, driver/controller, magnetics, PCB and case) for typical 65W mobile charger.

(2) Based on Navitas production release of 650V GaN power IC in Q3 '18.



Leadership in: System Design, Capacity, Roadmap & Climate



System Design

- #1 in GaN, #1 in high-freq. power, #1 in planar transformer
- Shanghai, Hangzhou, Shenzhen, Los Angeles
- Dedicated customer support from concept to MP

World's smallest:



50W PPS
500 kHz



65W PD
400 kHz



1kW 400V DC-DC 1/4-brick
825 kHz

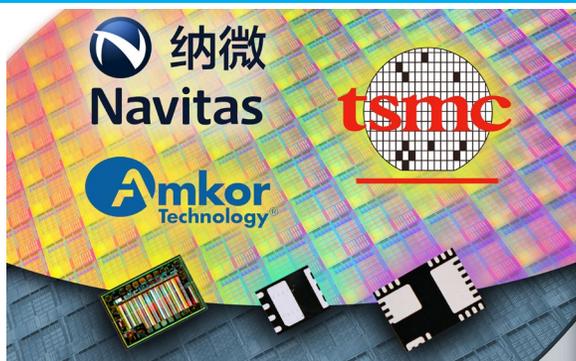
Roadmap



- New generation every 9-12 months
- 20-30% better cost/performance every generation
- Higher:
 - Frequency
 - Efficiency
 - Integration
 - Power density



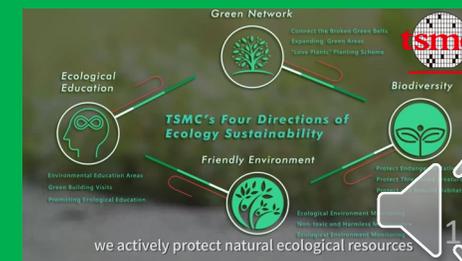
Capacity

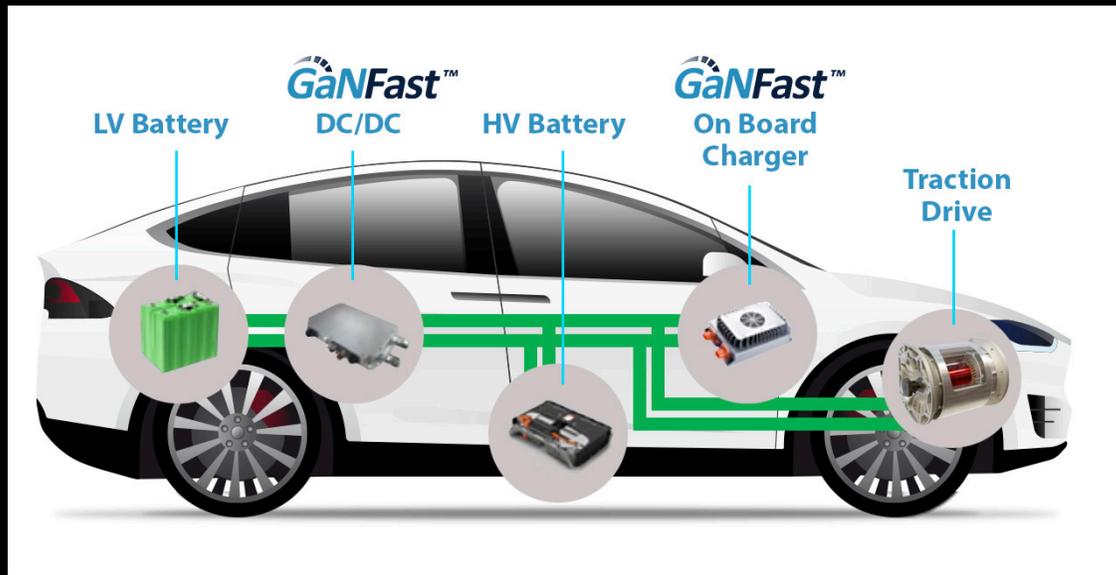


- Production since 2018, #1 in GaN shipments
- >300% capacity increase planned for 2022
- 3-5x more die per wafer compared to Silicon

Sustainability

- “Electrify Our World™”
- GaN can impact >33 Gtons of cumulative CO₂ reduction by 2050
- Navitas NetZero program
- CO₂ ‘Total Lifecycle Analysis’
 - GaN charger has 50% lower CO₂ footprint than silicon
- Target to support suppliers’ and customers’ sustainability goals

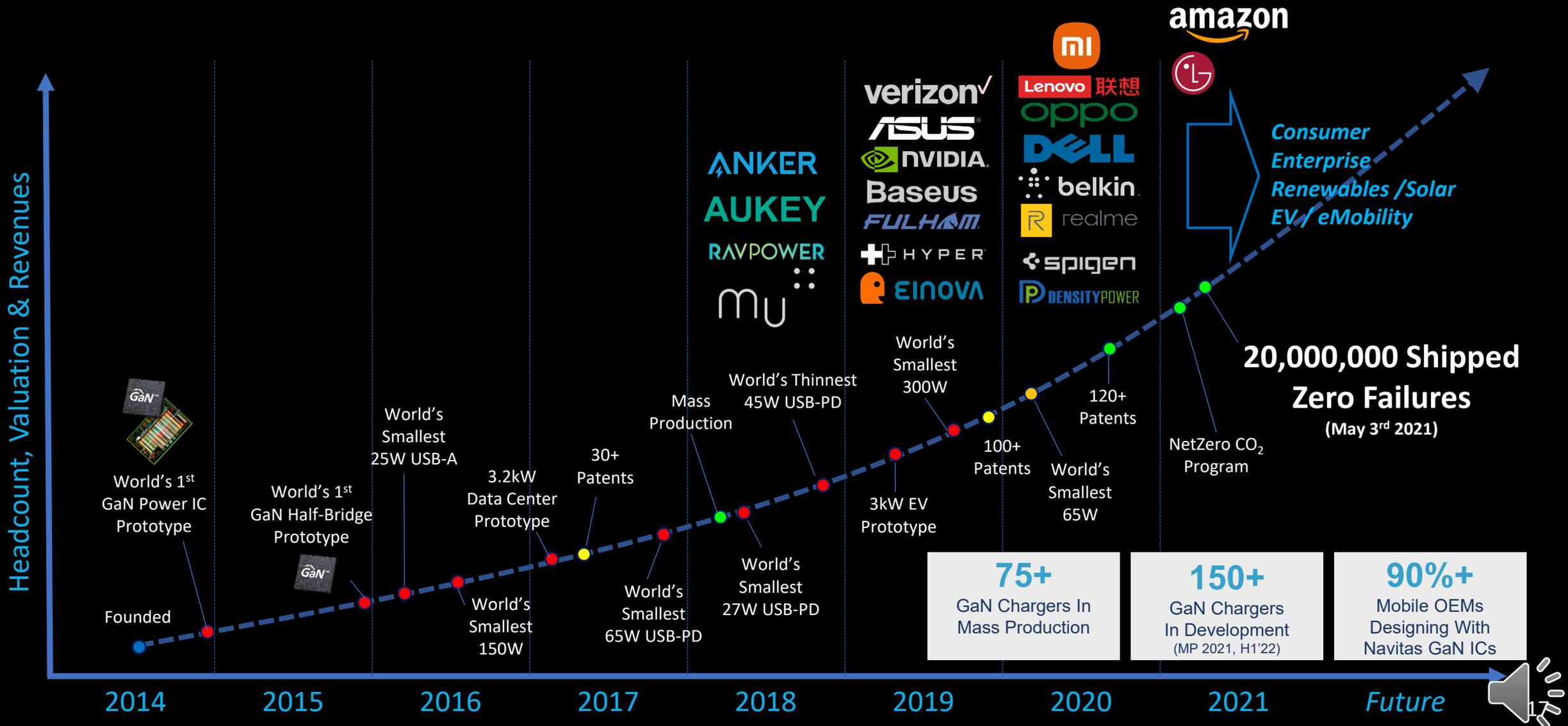




Energy, Efficiency & Sustainability Apply to All Markets

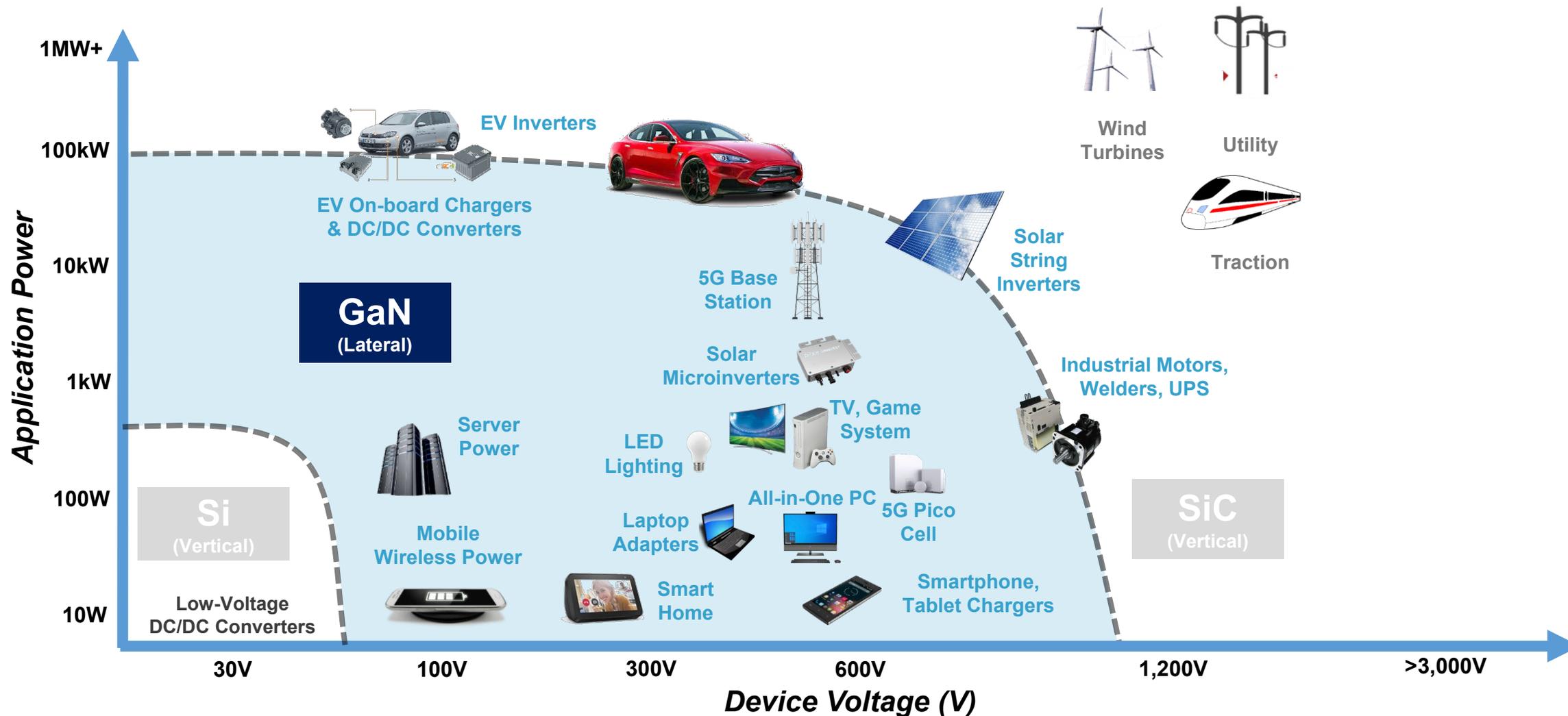


Generating Exciting Growth



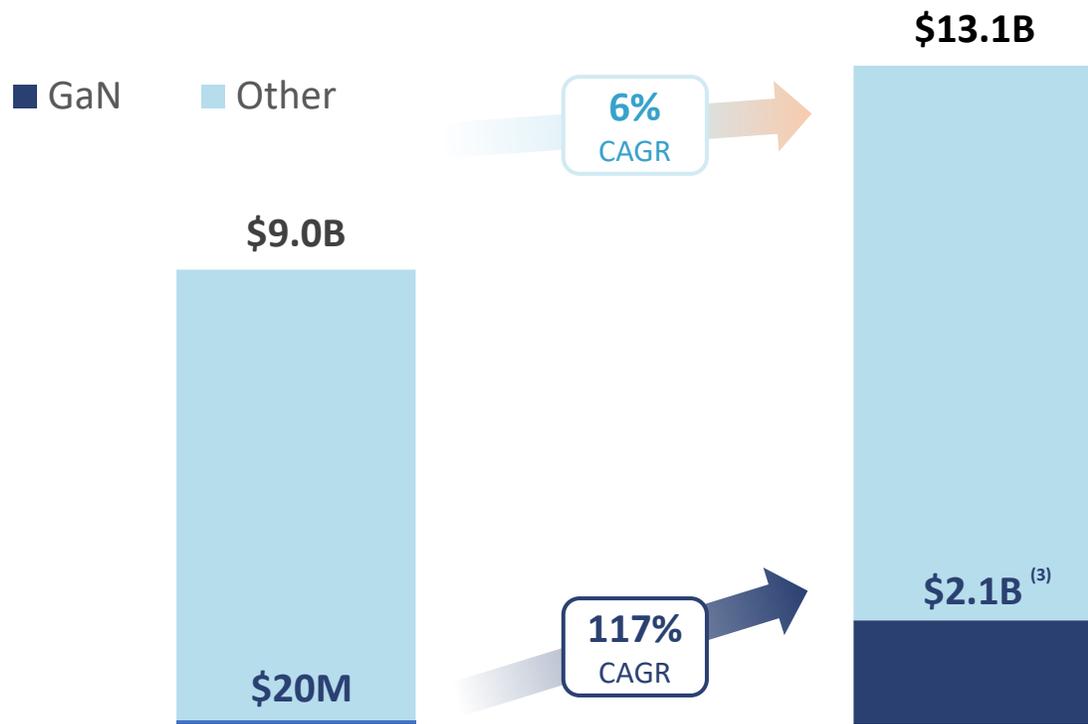
Note: Charger metrics as of March 2021.

In Broad Markets & Applications



GaN ICs Address a \$13B TAM

GaN Grows 20x Faster Than Total Power Semi TAM^(1,2)

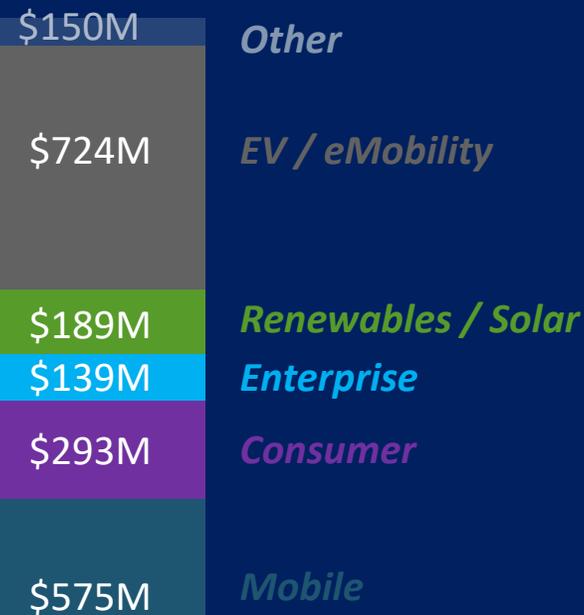


GaN
% Market Penetration



GaN 2026 TAM⁽²⁾

\$2.1B⁽³⁾



2026



(1) GaN IC potential market based on voltage rating of 80V – 1,000V derived from Yole Développement, Status of the Power Electronic Industry 2020.
 (2) IHS SiC GaN Power Semiconductors Report 2020, Yole Power Devices Summary – 2019-25, expert interviews.
 (3) Reflects midpoint of forecasted 2026 market size range of \$1.6 billion to \$2.6 billion.

Join the GaN Generation!



www.navitassemi.com
www.ganfast.com



Let's go GaNFast 